



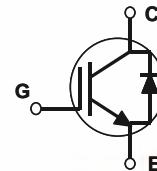
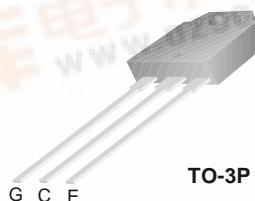
FGA25N120AND

General Description

Employing NPT technology, Fairchild's AND series of IGBTs provides low conduction and switching losses. The AND series offers a solution for application such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

Applications

Induction Heating, UPS, AC & DC motor controls and general purpose inverters.



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description	FGA25N120AND	Units
V _{CES}	Collector-Emitter Voltage	1200	V
V _{GES}	Gate-Emitter Voltage	± 20	V
I _C	Collector Current @ T _C = 25°C	40	A
	Collector Current @ T _C = 100°C	25	A
I _{CM(1)}	Pulsed Collector Current	75	A
I _F	Diode Continuous Forward Current @ T _C = 100°C	25	A
I _{FM}	Diode Maximum Forward Current	150	A
P _D	Maximum Power Dissipation @ T _C = 25°C	310	W
	Maximum Power Dissipation @ T _C = 100°C	125	W
T _J	Operating Junction Temperature	-55 to +150	°C
T _{stg}	Storage Temperature Range	-55 to +150	°C
T _L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	300	°C

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
R _{θJC} (IGBT)	Thermal Resistance, Junction-to-Case	--	0.4	°C/W
R _{θJC} (DIODE)	Thermal Resistance, Junction-to-Case	--	2.0	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	--	40	°C/W

Electrical Characteristics of the IGBT

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0\text{V}, I_C = 3\text{mA}$	1200	--	--	V
$\Delta B_{V_{CES}}/\Delta T_J$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0\text{V}, I_C = 3\text{mA}$	--	0.6	--	$\text{V}/^\circ\text{C}$
I_{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0\text{V}$	--	--	3	mA
I_{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0\text{V}$	--	--	± 100	nA

On Characteristics

$V_{GE(\text{th})}$	G-E Threshold Voltage	$I_C = 25\text{mA}, V_{CE} = V_{GE}$	3.5	5.5	7.5	V
$V_{CE(\text{sat})}$	Collector to Emitter Saturation Voltage	$I_C = 25\text{A}, V_{GE} = 15\text{V}$	--	2.5	3.2	V
		$I_C = 25\text{A}, V_{GE} = 15\text{V}, T_C = 125^\circ\text{C}$	--	2.9	--	V
		$I_C = 40\text{A}, V_{GE} = 15\text{V}$	--	3.1	--	V

Dynamic Characteristics

C_{ies}	Input Capacitance	$V_{CE} = 30\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$	--	2100	--	pF
C_{oes}	Output Capacitance		--	180	--	pF
C_{res}	Reverse Transfer Capacitance		--	90	--	pF

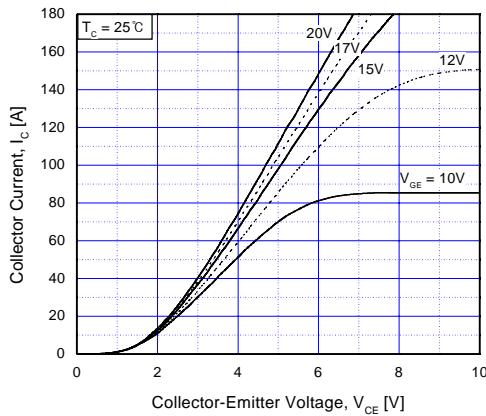
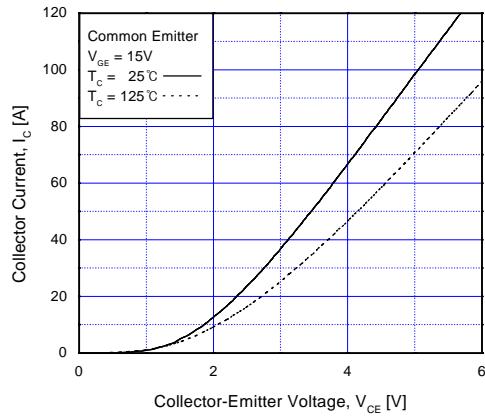
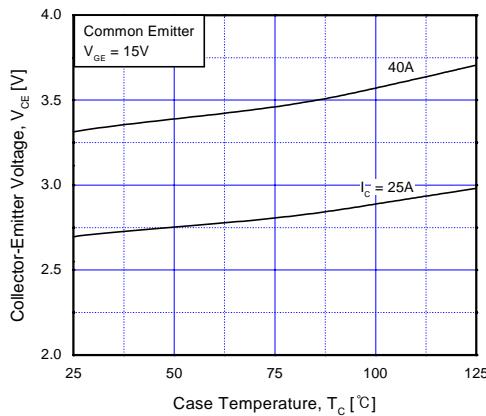
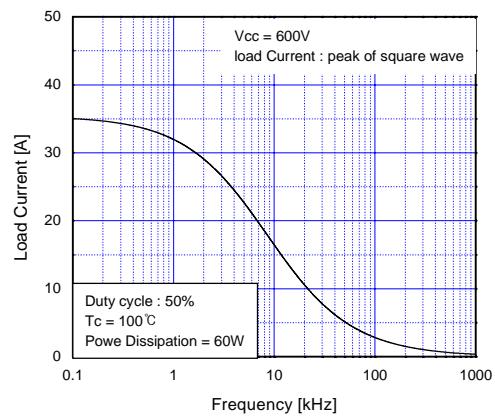
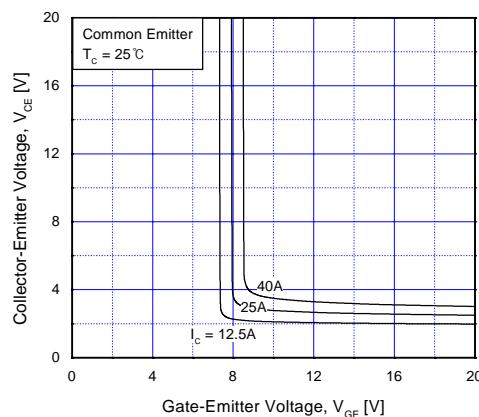
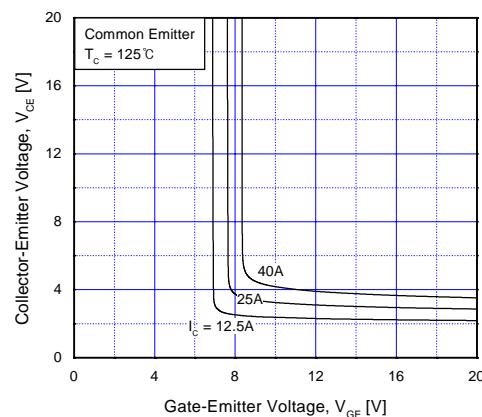
Switching Characteristics

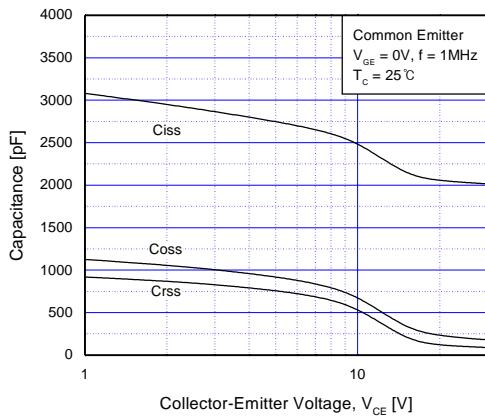
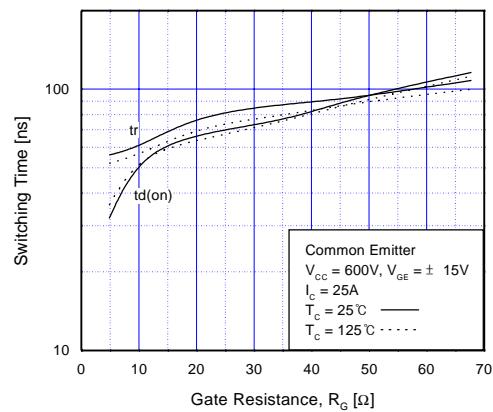
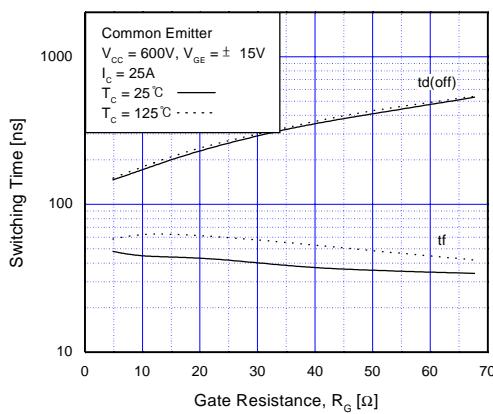
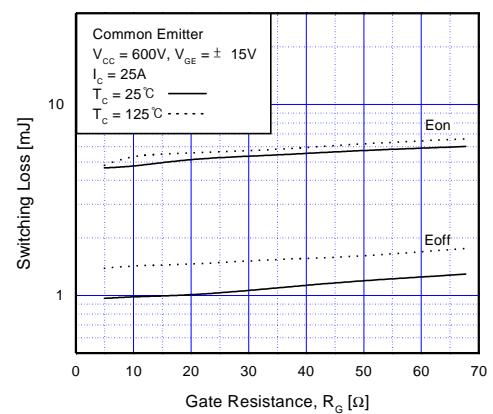
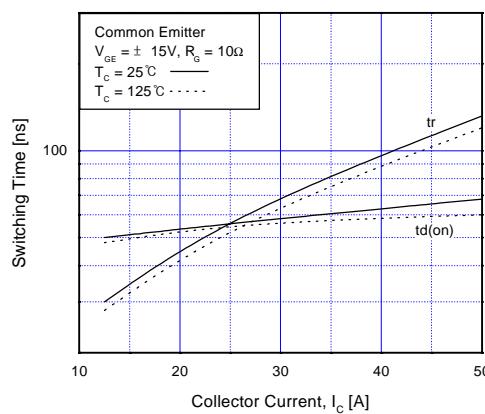
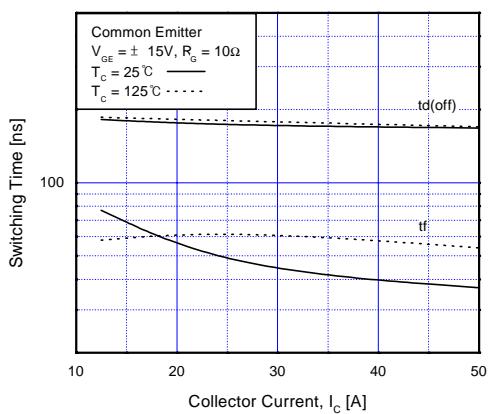
$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 600\text{ V}, I_C = 25\text{A}, R_G = 10\Omega, V_{GE} = 15\text{V}, \text{Inductive Load, } T_C = 25^\circ\text{C}$	--	60	--	ns
t_r	Rise Time		--	60	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	170	--	ns
t_f	Fall Time		--	45	90	ns
E_{on}	Turn-On Switching Loss		--	4.8	7.2	mJ
E_{off}	Turn-Off Switching Loss		--	1.0	1.5	mJ
E_{ts}	Total Switching Loss		--	5.7	8.7	mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 600\text{ V}, I_C = 25\text{A}, R_G = 10\Omega, V_{GE} = 15\text{V}, \text{Inductive Load, } T_C = 125^\circ\text{C}$	--	60	--	ns
t_r	Rise Time		--	60	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	180	--	ns
t_f	Fall Time		--	70	--	ns
E_{on}	Turn-On Switching Loss		--	5.5	--	mJ
E_{off}	Turn-Off Switching Loss		--	1.4	--	mJ
E_{ts}	Total Switching Loss		--	6.9	--	mJ
Q_g	Total Gate Charge	$V_{CE} = 600\text{ V}, I_C = 25\text{A}, V_{GE} = 15\text{V}$	--	200	300	nC
Q_{ge}	Gate-Emitter Charge		--	15	23	nC
Q_{gc}	Gate-Collector Charge		--	105	160	nC
L_e	Internal Emitter Inductance	Measured 5mm from PKG	--	14	--	nH

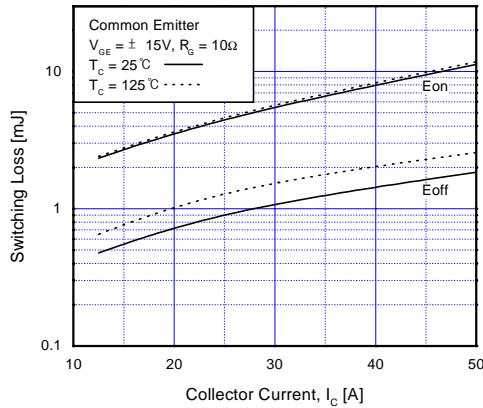
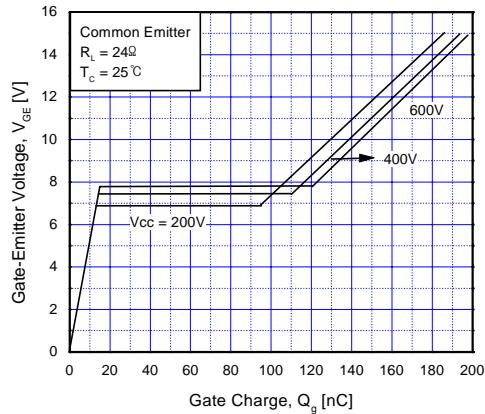
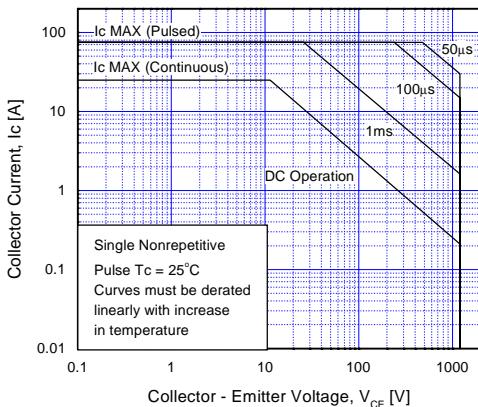
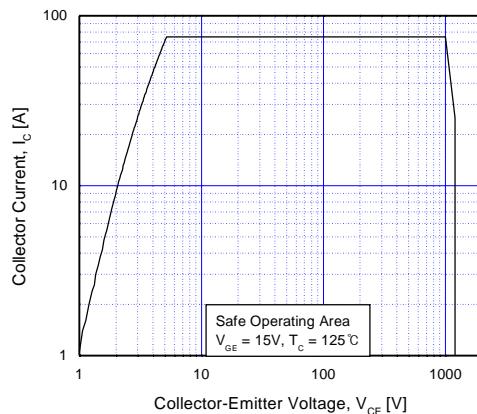
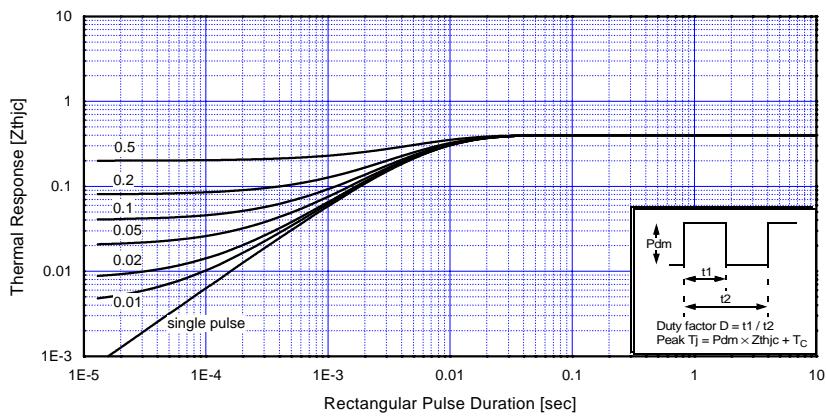
Electrical Characteristics of DIODE

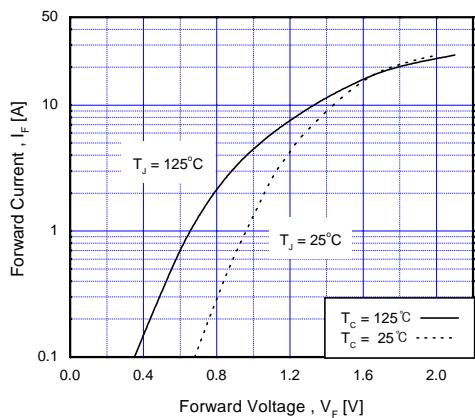
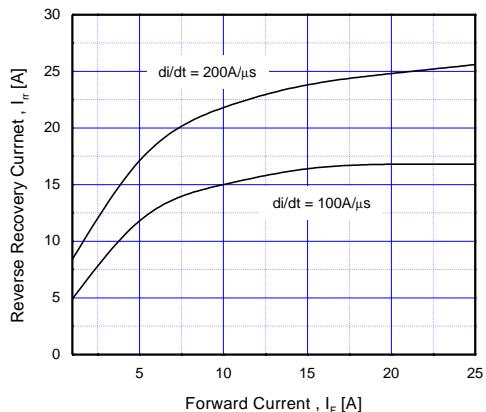
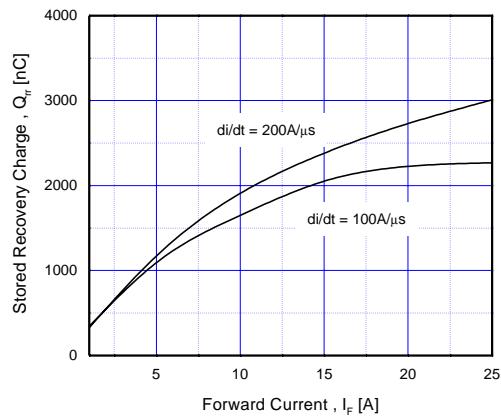
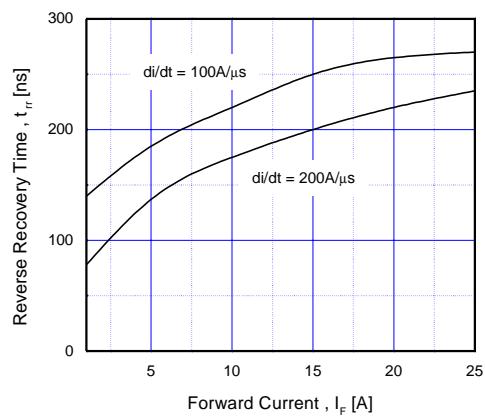
$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{FM}	Diode Forward Voltage	$I_F = 25\text{A}$	$T_C = 25^\circ\text{C}$	--	2.0	3.0
			$T_C = 125^\circ\text{C}$	--	2.1	--
t_{rr}	Diode Reverse Recovery Time	$I_F = 25\text{A}$ $dI/dt = 200\text{ A}/\mu\text{s}$	$T_C = 25^\circ\text{C}$	--	235	350
			$T_C = 125^\circ\text{C}$	--	300	--
I_{rr}	Diode Peak Reverse Recovery Current	$I_F = 25\text{A}$ $dI/dt = 200\text{ A}/\mu\text{s}$	$T_C = 25^\circ\text{C}$	--	27	40
			$T_C = 125^\circ\text{C}$	--	31	--
Q_{rr}	Diode Reverse Recovery Charge		$T_C = 25^\circ\text{C}$	--	3130	4700
			$T_C = 125^\circ\text{C}$	--	4650	--


Fig 1. Typical Output Characteristics

Fig 2. Typical Saturation Voltage Characteristics

Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

Fig 4. Load Current vs. Frequency

Fig 5. Saturation Voltage vs. V_{GE}

Fig 6. Saturation Voltage vs. V_{GE}


Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs. Gate Resistance

Fig 9. Turn-Off Characteristics vs. Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance

Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs. Collector Current

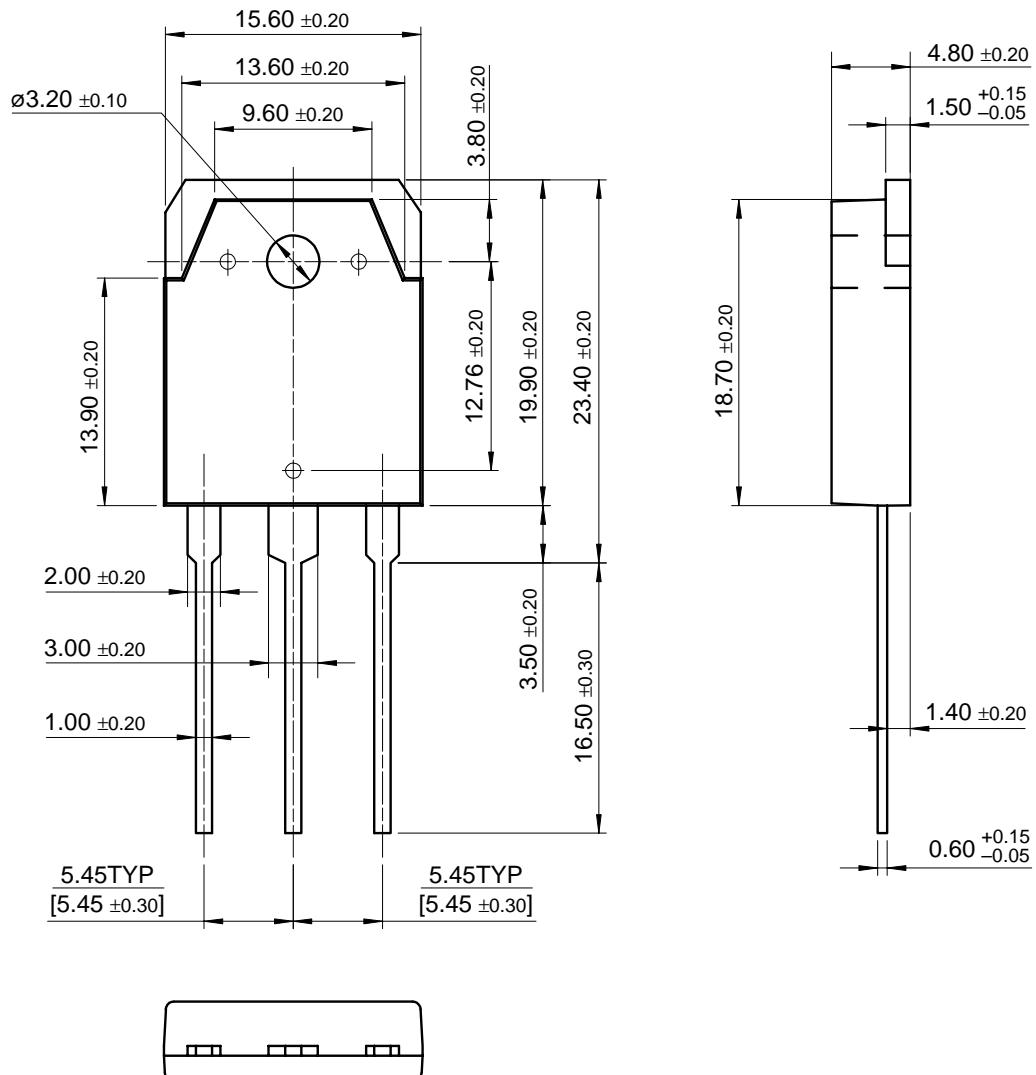

Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics

Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA

Fig 17. Transient Thermal Impedance of IGBT

**Fig 18. Forward Characteristics****Fig 19. Reverse Recovery Current****Fig 20. Stored Charge****Fig 21. Reverse Recovery Time**

FGA25N120AND

Package Dimension

TO-3P



Dimensions in Millimeters

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